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P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
- 30	0.0098 at V _{GS} = 10 V	- 19.7	27 nC			
- 30	0.0165 at V _{GS} = 4.5 V	- 15.2	27 110			

SO-8 S D D S

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Top View

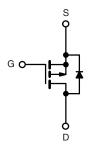
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g Tested

COMPLIANT HALOGEN **FREE**

APPLICATIONS

- Load Switches
 - Notebook PCs
 - Desktop PCs



P-Channel MOSFET

Ordering Information	: Si4425DDY-T1-GE3	(Lead (Pb)-free	and Halogen-free)
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ABSOLUTE MAXIMUM RATIN	IGS T _A = 25 °C,	unless othe	erwise noted	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	- 30	V
Gate-Source Voltage		V_{GS}	± 20	_ v
	T _C = 25 °C		- 19.7	
Continuous Proin Current (T = 150 °C)	T _C = 70 °C	1 .	- 15.7	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	- I _D	- 13 ^{b, c}	
	T _A = 70 °C		- 10.4 ^{b, c}	Α
Pulsed Drain Current	•	I _{DM}	- 50	
Continous Source-Drain Diode Current	T _C = 25 °C	1.	- 4.7	
Continuus Source-Dialii Diode Current	T _A = 25 °C	- I _S	- 2.1 ^{b, c}	
	T _C = 25 °C		5.7	
Maximum Power Dissipation	T _C = 70 °C	P _D	3.6	w
	T _A = 25 °C		2.5 ^{b, c}	
	T _A = 70 °C	1	1.6 ^{b, c}	
Operating Junction and Storage Temperatur	e Range	T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d} t ≤ 10 s		R _{thJA}	35	50	°C/W		
Maximum Junction-to-Foot (Drain) Steady State		R _{thJF}	18	22	C/VV		

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- d. Maximum under Steady State conditions is 85 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 - 2504		- 20		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		4.9		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = -250 \mu A$	- 1.2		- 2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zava Cata Valtaga Dvain Cuvvant	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V			- 1	μΑ
Zero Gate Voltage Drain Current		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C			- 5	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 30			Α
Dynin Course On Ctota Basistanas	В	V _{GS} = - 10 V, I _D = - 13 A		0.0081	0.0098	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 10 A		0.0137	0.0165	Ω
Forward Transconductance ^a	g _{fs}	V _{DS} = - 15 V, I _D = - 13 A		40		S
Dynamic ^b						
Input Capacitance	C _{iss}			2610		
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		460		pF
Reverse Transfer Capacitance	C _{rss}]		395		
Total Cata Charge	Qg	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 13 A		53	80	nC
Total Gate Charge				27	41	
Gate-Source Charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -13 \text{ A}$		8		
Gate-Drain Charge	Q_{gd}			13		
Gate Resistance	R_g	f = 1 MHz	0.4	2.1	4.2	Ω
Turn-On Delay Time	t _{d(on)}			52	78	
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$		41	62	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 10 A, $V_{GEN} =$ - 4.5 V, $R_g =$ 1 Ω		36	54	
Fall Time	t _f			15	25	
Turn-On Delay Time	t _{d(on)}			12	20	ns
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$		9	15	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -10 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		42	63	
Fall Time	t _f			9	15	
Drain-Source Body Diode Characteristi	cs					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 4.7	Α
Pulse Diode Forward Current	I _{SM}				- 50	
Body Diode Voltage	V_{SD}	I _S = - 10 A, V _{GS} = 0 V		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			20	30	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 10 A, dl/dt = 100 A/μs, T _J = 25 °C		10	20	nC
Reverse Recovery Fall Time	t _a			10		nc
Reverse Recovery Rise Time t _b]		9		ns

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

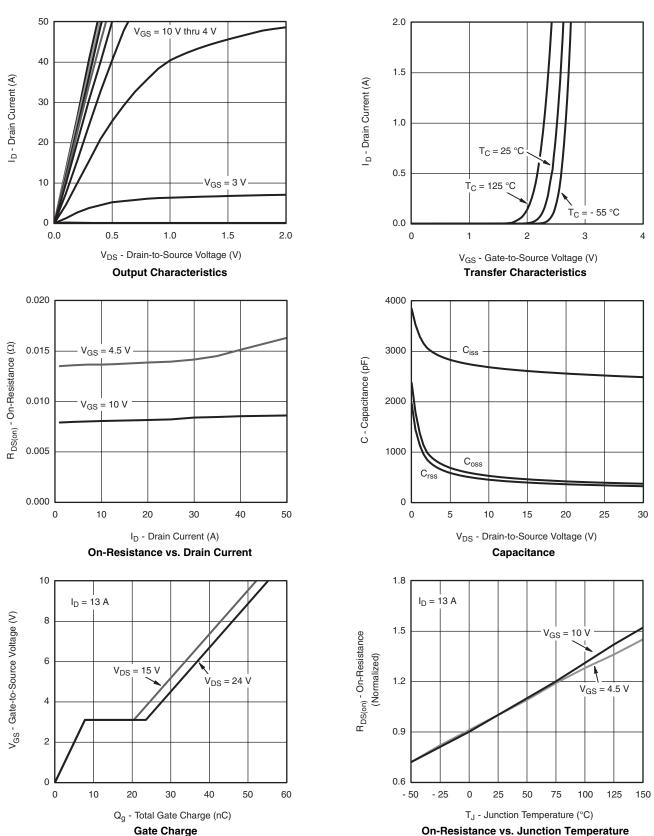
a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.





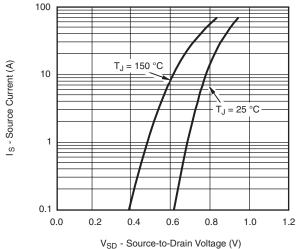
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



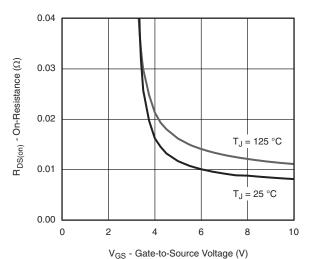
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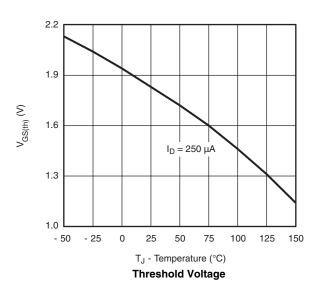
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

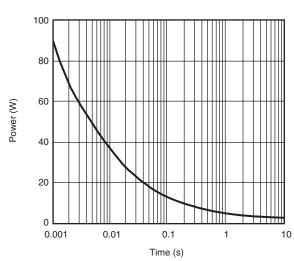


Source-Drain Diode Forward Voltage

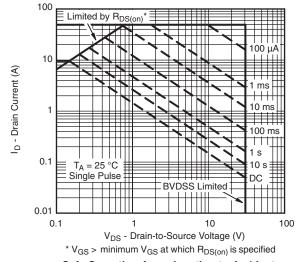


On-Resistance vs. Gate-to-Source Voltage



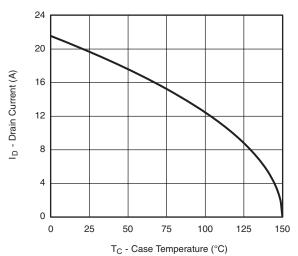


Single Pulse Power (Junction-to-Ambient)

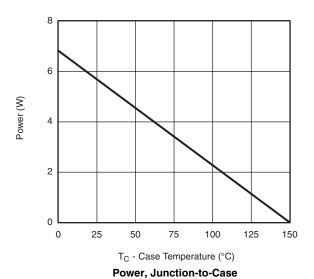


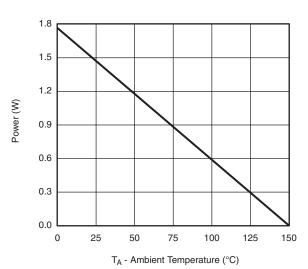


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*





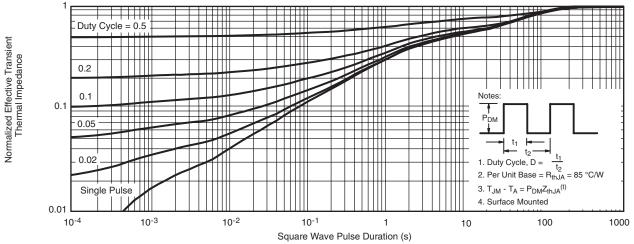
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

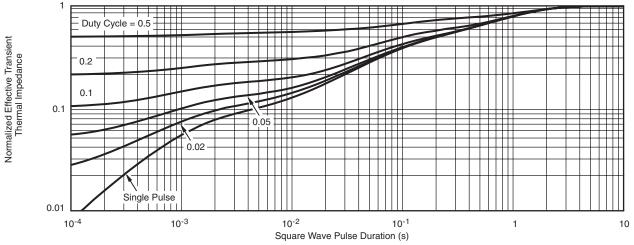
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

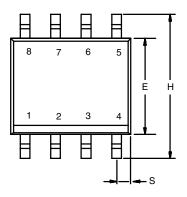


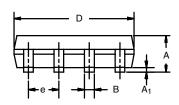
Normalized Thermal Transient Impedance, Junction-to-Foot

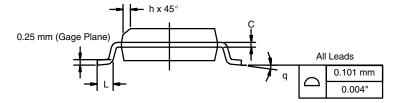
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS		INCHES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

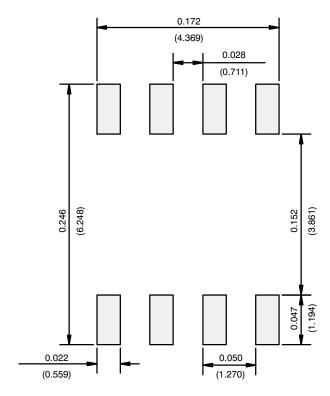
DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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